SPECIFICATION

Revision: 0.0

WKS43235

This module uses ROHS material

This specification may change without prior notice in order to improve performance or quality. Please contact R&D department for updated specification and product status before design for this product or release of this order.

WRITTEN BY	CHECKED BY	APPROVED BY
Jason	Tim	Sandy

REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
0.0	2022-10-23	First release	Preliminary

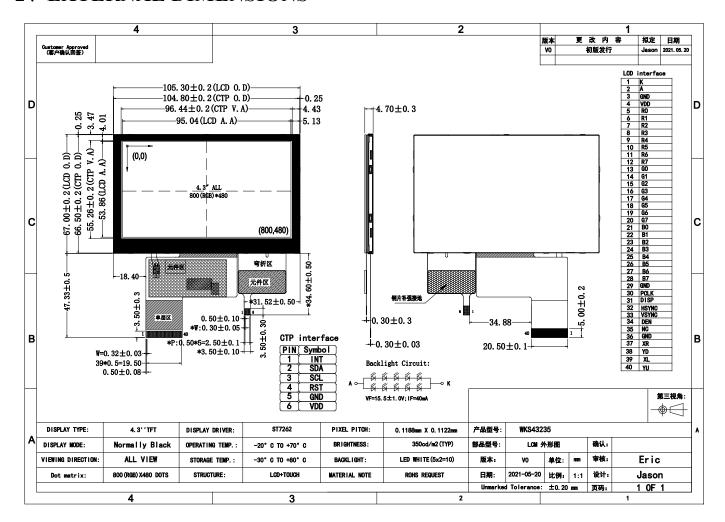
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1. GENERAL INFORMATION

Item of general information	Contents	Unit
LCD Display Size (Diagonal)	4.3	inch
LCD Display Type	TFT	-
LCD Display Mode	Normally Black	-
Recommended Viewing Direction	ALL VIEW	-
Module size (W×H×T)	105.30×67.00×4.70	mm
Active area (W×H)	95.04×53.86	mm
Number of pixels (Resolution)	800(RGB)×480	pixel
Pixel pitch (W×H)	0.1188×0.1122	mm
Color Pixel Arrangement	RGB Stripe	-
LCD Driver IC	-	-
Interface Type	Parallel 24bit RGB interface	-
Input voltage	3.3V	V
Power consumption	<u>-</u>	mA
Color Numbers	16.7M	-
Backlight Type	White LED	-

2 EXTERNAL DIMENSIONS



3 ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max 60°C)	RH

Note: Absolute maximum ratings mean the product can withstand short-term, not more than 120 hours. If the product is a long time to withstand these conditions, the life time would be shorter.

4、ELECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

Parameter of DC	Symbol	Min.	Тур.	Max.	Unit
characteristics					
LCD operating voltage	VDD	2.7	3.3	3.6	V
Input voltage 'H' level	VIH	0.7*VDD	-	VDD	V
Input voltage 'L' level	VIL	VSS	-	0.3*VDD	V
Output voltage 'H' level	VOH	VDD-0.4	-	VDD	V
Output voltage 'L' level	VOL	VSS	-	VSS+0.4	V

5. BACKLIGHT CHARACTERISTICS

Item of backlight characteristics	Symbol	Min.	Тур.	Max.	Unit	Remark
Forward Voltage	Vf	14.5	15.5	16.5	V	Note1
Forward Current	If	-	40	-	mA	-
Number of LED	-	-	5×2=10	-	Piece	-
LED Connection mode	S/P	-	Serial/Parallel	-	-	-
Lifetime of LED	-	-	10000	-	hour	Note2

Note:

- Note1: The LED Supply Voltage is defined by the number of LED at Ta=25°C and If=40mA.
- Note2: The LED lifetime define as the estimated time to 50% degradation of initial luminous. The LED lifetime could be decreased if operating If is larger than 40mA.

6. TOUCH CHARACTERISTICS

Item of CTP	Specification	Unit	Remark
Panel Type	Glass Cover + Glass Sensor	-	-
Resolution	800×480	pixel	-
Surface Hardness	6Н	-	-
Transparency	≥82%	-	-
Driver IC	GT1151Q	-	-
Interface Type	I2C	-	-
Support Points	5(Max)	-	-
Sampling Rate	20~100	Hz	-
Supply voltage	3.3	V	-

7. ELECTRO-OPTICAL CHARACTERISTICS

Item (of								
electro-op	otical	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
character	ristics								
Response	time	Tr+Tf	0.0	-	30	40	ms	FIG 1.	4
Contrast F	Ratio	CR	θ=0 ∅=0	640	800	-	-	FIG 2.	1
Luminance un	iformity	δWHITE	Ta=25°C	-	80	-	%	FIG 2.	3
Surface Lum	inance	Lv		-	350	-	cd/m2	FIG 2.	2
	White	White x		0.309	0.313	0.315			
	WIIILE	White y		0.337	0.339	0.341			
	Red	Red x		0.629	0.631	0.633			
CIE (x, y)	Reu	Red y	θ=0 ∅=0	0.327	0.329	0.331		FIG 2.	5
chromaticity	Green	Green x	Ta=25°C	0.326	0.328	0.330	_	FIG 2.	3
	Green	Green y	14 25 0	0.546	0.548	0.550			
	Dlus	Blue x		0.134	0.136	0.138			
	Blue	Blue y		0.139	0.141	0.143			
	Ø=90(1	2 o'clock)		70	80	-	deg		
Viewing	Ø=270(6 o'clock)	$CR \ge 10$	70	80	-	deg	FIG 3.	6
angle range	Ø=0(3 d	o'clock)	CK 2 10	70	80	-	deg	FIG 3.	0
	Ø=180(9 o'clock)		70	80	-	deg		
NTSC ratio		-	-	-	50	-	%	-	-

Note 1. Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

 $Contrast \ Ratio(CR) = \frac{Average \ Surface \ Luminance \ with \ all \ white \ pixels(P1, P2, P3, P4, P5, P6, P7, P8, P9)}{Average \ Surface \ Luminance \ with \ all \ black \ pixels(P1, P2, P3, P4, P5, P6, P7, P8, P9)}$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P3,P4,P5,P6,P7,P8,P9)

Note 3. The uniformity in surface luminance (δ WHITE) is determined by measuring luminance at each test position 1 through 9, and then dividing the maximum luminance of

9points luminance by minimum luminance of 9 points luminance. For more information see FIG 2.

$$\delta \text{WHITE} = \frac{\textit{Minimum Surface Luminance with all white pixels} (P1, P2, P3, P4, P5, P6, P7, P8, P9)}{\textit{Maximum Surface Luminance with all white pixels} (P1, P2, P3, P4, P5, P6, P7, P8, P9)}$$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1.

Note 5. CIE (x, y) chromaticity, The x,y value is determined by screen active area position 5. For more information see FIG 2.

Note 6. Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

Note 8. For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time

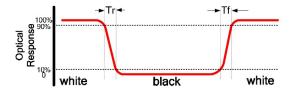


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance

uniformity, CIE (x, y) chromaticity

A: H/6; B: V/6;

H,V: Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

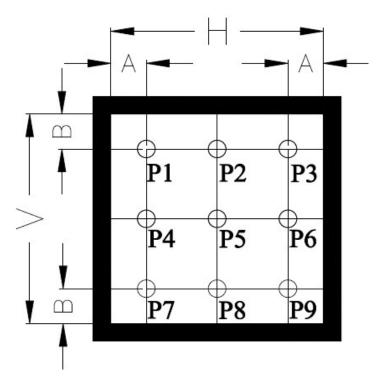
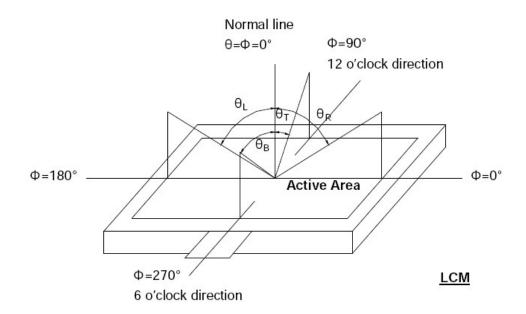


FIG.3. The definition of viewing angle



8. INTERFACE DESCRIPTI

A. LCD Interface Description

NO.	Symbol	I/O	DESCRIPTION	
1	LED-K	Power supply	Backlight Cathode	
2	LED-A	Power supply	Backlight Anode	
3	GND	Power supply	Power ground	
4	VDD	Power supply	Digital Power supply(3.3V Typ.)	
5~12	R0~R7	I	8bit digital Red data input(R0:LSB; R7:MSB)	
13~20	G0~G7	I	8bit digital Green data input(G0:LSB; G7:MSB)	
21~28	B0~B7	I	8bit digital Blue data input(B0:LSB; B7:MSB)	
29	GND	Power supply	Power ground	
30	DCLK	I	Clock signal. Latching data at the rising edge.	
31	DISP	I	Standby setting pin, it should be connected to VDD in normal operation mode. If connected to GND, the driver IC is in standby mode.	
32	HSYNC	I	Horizontal Sync input. Negative polarity.	
33	VSYNC	I	Vertical Sync input. Negative polarity.	
34	DEN	I	Data input Enable. Active high to enable the data input Bus.	
35	NC	-	No Connection	
36	GND	Power supply	Power ground	
37	XR	-	RTP pin	
38	YD	-	RTP pin	
39	XL	-	RTP pin	
40	YU	-	RTP pin	

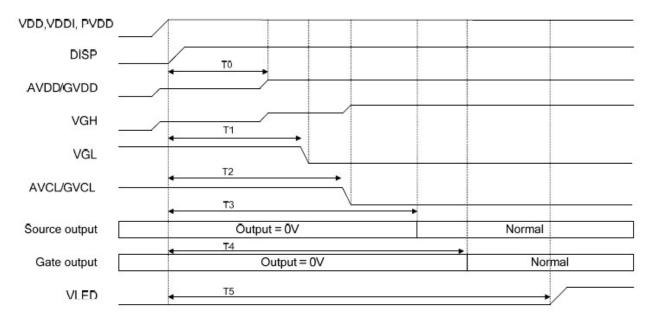
B. TOUCH Interface Description

NO.	Symbol	I/O	DESCRIPTION
1	INT	О	CTP External interrupt to the host
2	SDA	I/O	CTP I2C data input and output
3	SCL	I	CTP I2C clock input
4	RESET	I	CTP external reset signal, Low is active
5	GND	Power supply	Power ground
6	VDD	Power supply	CTP Power input

9、INPUT TIMING

Parameter	Symbol	Value			Unit
rarameter	Symbol	Min.	Тур.	Max.	Unit
PCLK frequency@ Frame rate=60Hz	PCLK	-	30	50	MHz
Horizontal display area	thd		800		PCLK
Horizontal period time	th	889	928	1143	PCLK
HSYNC Back Porch	thbp	-	88	-	PCLK
HSYNC Front Porch	thfp	1	40	255	PCLK
HSYNC Pulse Width	thw	1	48	255	PCLK
Vertical display area	tvd	480			Н
VSYNC period time	tv	513	525	767	Н
VSYNC Back Porch	tvbp	-	32	-	Н
VSYNC Front Porch	tvfp	1	13	255	Н
VSYNC Pulse Width	tvw	3	3	255	Н

10. POWER ON SEQUENCE



Symbol	Description	Min. Time	Unit
ТО	DISP="High" to AVDD/GVDD voltage stability	40	ms
T1	DISP="High" to VGL voltage stability	50	ms
T2	DISP="High" to AVCL/GVCL stability	70	ms
Т3	DISP="High" to Source output	100	ms
T4	DISP="High" to Gate output	110	ms
T5	Black Turn on	130	ms

11, RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition				
1	High Temperature Storage	80°C/120 hours				
2	Low Temperature Storage	-30°C/120 hours				
3	High Temperature Operating	70°C/120 hours				
4	Low Temperature Operating	-20°C/120 hours				
5	Temperature Cycle Storage	-20°C(30min.)~25(5min.)~70°C(30min.)×10cycles				

A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- Air bubble in the LCD;
- Sealleak;
- ➤ Non-display;
- ➤ Missing segments;
- ➤ Glass crack;
- Current is twice higher than initial value.

B, Remark:

- ➤ The test samples should be applied to only one test item.
- \triangleright Sample size for each test item is 5~10pcs.
- ➤ Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

12 INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 3.5 inch.

12. 1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65

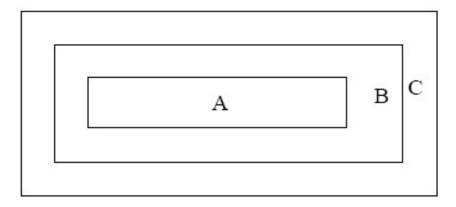
Minor defect: AQL 1.5

12.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of $20\sim40$ W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature $20\sim25^{\circ}$ C and normal humidity 60 $\pm15\%$ RH)

12.3 Definition of Inspection Item

A. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

B, Definition of some visual defect

	Because of losing all or part function, bad pixel dots appear bright and the					
Bright dot	size is more than 50% of one dot in which LCD panel is displaying under					
	black pattern.					
Dark dot	Dots appear dark and unchanged in size in which LCD panel is displaying					
	under pure red, green, blue picture, or pure whiter picture.					

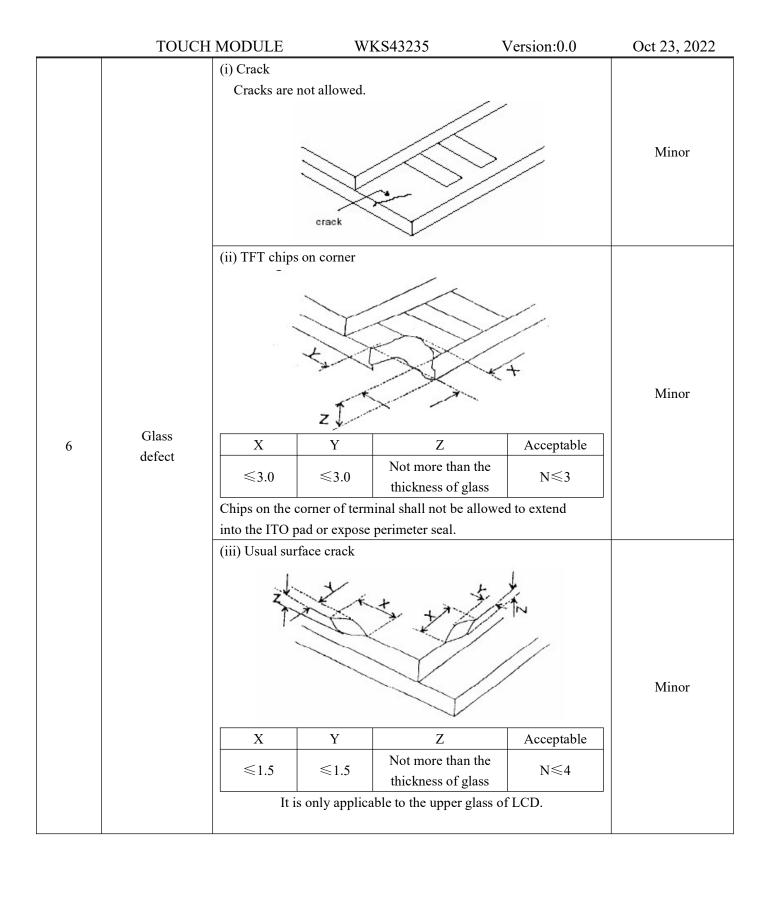
12.4 Major Defect

Item No.	Items to be inspected	Inspection standard	Classification of defects
1	Functional defects	1) No display 2) Display abnormally 3) Missing vertical, horizontal segment 4) Short circuit 5) Excess power consumption 6)Backlight no lighting, flickering and abnormal lighting	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

12.5 Minor Defect

Item No.	Items to be inspected	Inspection standard							Classification of defects		
			Zone	Acceptable Qty							
				A+B							
					3.5~	7"	7∼10.1"	>	>10.1"	С	
		Bright pixel dot		t	1		2		3		
	Bright dot	Dark pixel dot			4		4		4	Acc	
1	/dark dot	2brigh	nt dots adja	cent	0)	0		0	Acceptable	Minor
	defect	2dark	c dots adjac	ent	0)	0		0	ble	
			ight and da		5		6		7		
			nimum dist								
			' function			_			-	gn	
		material a	and other re Zone	asons ar	e judg				et of 5.2.	1	
	Dot defect		Acceptable Qty								
		a: ()				A+B					
			Size(mm)		~7" ——		~10.1"		10.1"	С	
		Φ≤0.2		Accept	Acceptable A		cceptable		Acceptable		
2		0.2< Ф ≤ 0.5		$0.2 < \Phi \le 0.5$ 4 5 6 $\frac{\text{Cept}}{\text{E}}$		Acceptable	Minor				
		ФЭ	0			0		0	ble		
			um distance antity of de							m;	
	Linear defect		Zone Acceptable Qty								
		Size (mm)		A+B							
		Length	Width	3.5"~	~7"	7~	~10.1"	>	10.1"	С	
3		Ignore	W≤0.05	Accept	table	Acc	eptable	Acc	eptable	Ac	Minor
		L≤5.0	0.05 < W≤0.1	4			5		6	Acceptable	
		L>5.0	W>0.1	0			0		0	le	

	TOUCH	MODUL	Е	WKS432	35	Version:0.	0	Oct 23, 2022
4	Polarizer defect	(i) Shiftir dimension (ii) Incorallowed. 5.4.2 Dirt Dirt which 5.4.3 Pola Size(mm 0.2<0 5.4.4 Pol (i) If the jor in the (ii) If the	on polarizer h can be warizer Dent Zone \$\int 0.2\$ \$\int 0.2\$ \$\int 0.5\$ Polarizer scrapolarizer soperating to polarizer in or some Zone	ering of the vier iped easily she & Air bubble 3.5"~7" Acceptable 4 0 atch scratch can b condition, ju	ewing area du ould be accept Acceptable A+B 7~10.1" Acceptable 5 0 e seen after codge by the libe seen only	able. Qty >10.1" Acceptable 6 0 cover assembnear defect of in non-operate following:	C Acceptable ling of 5.3.	Minor
	MURA	Using						
5	White/Black dot (MURA)	Vi 0.15	Minor					



12.6 Module Cosmetic Criteria

Item No.	Items to be inspected	Inspection Standard	Classification of defects		
1	Difference in Spec.	Not allowable	Major		
2	Pattern peeling	No substrate pattern peeling and floating	Major		
		No soldering missing	Major		
3	Soldering defects	No soldering bridge	Major		
		No cold soldering	Minor		
4	Resist flaw on PCB	Visible copper foil (Φ 0.5 mm or more) on substrate pattern is not allowed	Minor		
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major		
6	Backlight plastic frame	No deformation, crack, breaking, backlight positioning column breaking, obvious nick.	Minor		
7	Marking printing effect	No dark marking, incomplete, deformation lead to unable to judge	Minor		
8	Accretion of metallic Foreign matter	No accretion of metallic foreign matter (Not exceed Φ 0.2mm)	Minor		
9	Stain	No stain to spoil cosmetic badly	Minor		
10	Plate discoloring	No plate fading, rusting and discoloring	Minor		
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor		
	1. Lead parts	b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor		
	2. Flat packages	Minor			
11	3. Chips	(3/2) H ≥h ≥(1/2) H (3/2) H			
	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad h \geq 0.13 mm. The diameter of solder ball d \leq 0.15 mm.	Minor		
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor		
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major		